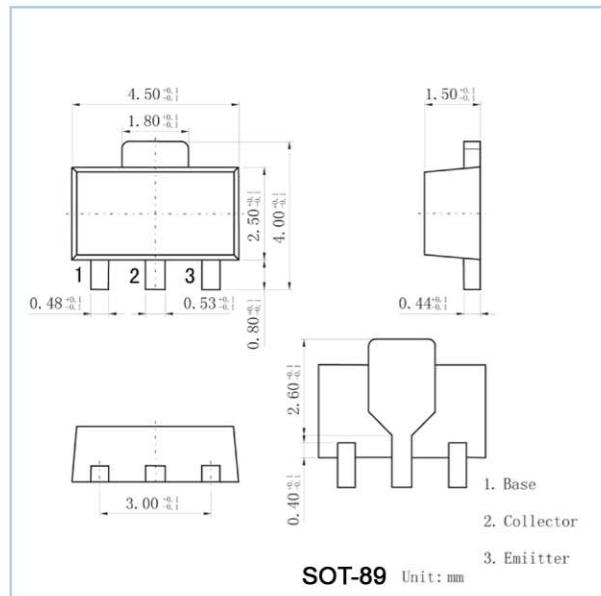


## ■ Features

- High current (max. 1 A).
- Low voltage (max. 45 V).



## ■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Collector-base voltage	V <sub>CBO</sub>	45	V
Collector-emitter voltage	V <sub>CEO</sub>	45	V
Emitter-base voltage	V <sub>EBO</sub>	5	V
Collector current (DC)	I <sub>C</sub>	1	A
Peak collector current	I <sub>CM</sub>	1.5	A
Peak base current	I <sub>BM</sub>	0.2	A
Power dissipation T <sub>a</sub> ≤ 25 °C *	P <sub>D</sub>	1.3	W
Operating ambient temperature	R <sub>amb</sub>	-65 to +150	°C
Thermal resistance from junction to ambient *	R <sub>th(j-a)</sub>	94	K/W
Thermal resistance from junction to solder point	R <sub>th(j-s)</sub>	14	K/W
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-65 to +150	°C

\* Device mounted on a printed-circuit board, single sided copper, tinplated, mounting pad for collector 6 cm<sup>2</sup>.

■ Electrical Characteristics  $T_a = 25^\circ\text{C}$ 

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = 30 \text{ V}, I_E = 0$			100	nA
		$V_{CB} = 30 \text{ V}, I_E = 0; T_j = 125^\circ\text{C}$			10	iA
Emitter cutoff current	$I_{EBO}$	$V_{EB} = 5 \text{ V}, I_C = 0$			100	nA
DC current gain	$h_{FE}$	$I_C = 5 \text{ mA}; V_{CE} = 2 \text{ V}$	40			
		$I_C = 150 \text{ mA}; V_{CE} = 2 \text{ V}$	63		250	
		$I_C = 500 \text{ mA}; V_{CE} = 2 \text{ V}$	25			
DC current gain BCX54-10 BCX54-16	$h_{FE}$	$I_C = 150 \text{ mA}; V_{CE} = 2 \text{ V};$	63		160	
			100		250	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$			0.5	V
Base to emitter voltage	$V_{BE}$	$I_C = 500 \text{ mA}; V_{CE} = 2 \text{ V}$			1	V
DC current gain ratio of the complementary pairs	$\frac{h_{FE}}{h_{FE}}$	$ I_C  = 150 \text{ mA};  V_{CE}  = 2\text{V}$		1.3	1.6	
Transition frequency	$f_T$	$I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}; f = 100 \text{ MHz}$		130		MHz

## ■ hFE Classification

TYPE	BCX54	BCX54-10	BCX54-16
Marking	BA	BC	BD